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FAN7190_F085 High-Current, High & Low-Side, Gate-Drive IC

Features

- Floating Channels for Bootstrap Operation to +600V
- Typically 4.5A/4.5A Sourcing/Sinking Current Driving Capability
- Common-Mode dv/dt Noise Canceling Circuit
- Built-in Under-Voltage Lockout for Both Channels
- Matched Propagation Delay for Both Channels
- 3.3V and 5V Input Logic Compatible
- Output In-phase with Input

Applications

- Diesel and gasoline Injectors/Valves
- MOSFET-and IGBT high side driver applications

Description

The FAN7190_F085 is a monolithic high- and low-side gate-drive IC, which can drive high speed MOSFETs and IGBTs that operate up to +600V. It has a buffered output stage with all NMOS transistors designed for high pulse current driving capability and minimum cross-conduction.

Fairchild's high-voltage process and common-mode noise canceling techniques provide stable operation of the high-side driver under high dv/dt noise circumstances. An advanced level shift circuit offers high-side gate driver operation up to $V_{\rm S}$ =-9.8V (typical) for $V_{\rm BS}$ =15V.

The UVLO circuit prevents malfunction when V_{DD} and V_{BS} are lower than the specified threshold voltage.

The high current and low output voltage drop feature make this device suitable for magnetic- and piezo type injectors and general MOSFET/IGBT based high side driver applications.



8-Lead, SOIC, Narrow Body

Ordering Information

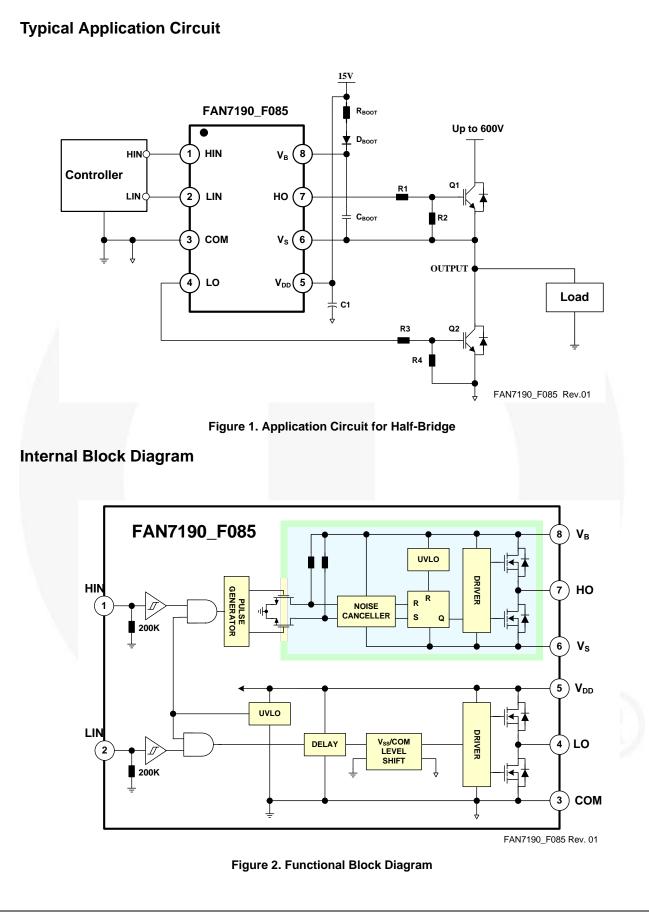
Part Number	Package	Operating Temperature Range	Eco Status	Packing Method
FAN7190M_F085	8-SOP	-40°C ∼ 125°C	RoHS	Tube
FAN7190MX_F085		-40 C ~ 123 C	Rono	Tape & Reel

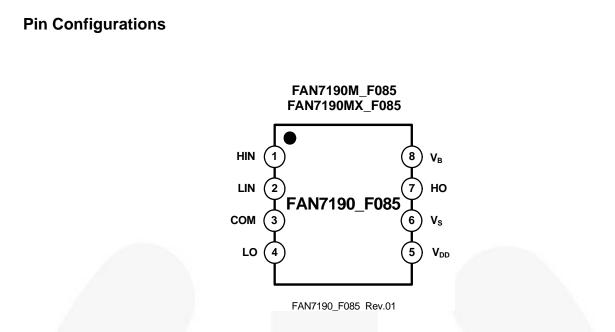
Notes:

1. These devices passed wave soldering test by JESD22A-111.

2. A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as Fairchild has officially announced in Aug 2014.

April 2016







Pin Definitions

8-Pin	Name	Description
1	HIN	Logic Input for High-Side Gate Driver Output
2	LIN	Logic Input for Low-Side Gate Driver Output
3	COM	Low-Side Driver Return
4	LO	Low-Side Driver Output
5	V _{DD}	Low-Side and Logic Part Supply Voltage
6	V _S	High-Voltage Floating Supply Return
7	HO	High-Side Driver Output
8	V _B	High-Side Floating Supply

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $-40^{\circ}C <=T_A <= 125^{\circ}C$, unless otherwise specified.

Symbol	Characteristics	Min.	Max.	Unit
V _S	High-Side Floating Supply Offset Voltage	V _B -25	V _B +0.3	V
V _B	High-Side Floating Supply Voltage	-0.3	625.0	V
V _{HO}	High-Side Floating Output Voltage HO	V _S -0.3	V _B +0.3	V
V _{DD}	Low-Side and Logic Fixed Supply Voltage	-0.3	25.0	V
V _{LO}	Low-Side Output Voltage LO	-0.3	V _{DD} +0.3	V
V _{IN}	Logic Input Voltage (HIN and LIN)	-0.3	V _{DD} +0.3	V
dV _S /dt	Allowable Offset Voltage Slew Rate		50	V/ns
P _D ⁽³⁾⁽⁴⁾⁽⁵⁾	Power Dissipation	8-SOP	0.625	W
θ _{JA}	Thermal Resistance, Junction-to-Ambient	8-SOP	200	°C/W
Т _Ј	Junction Temperature		+150	°C
T _{STG}	Storage Temperature		+150	°C

Notes:

- 3. Mounted on 76.2 x 114.3 x 1.6mm PCB (FR-4 glass epoxy material).
- 4. Refer to the following standards:

JESD51-2: Integral circuits thermal test method environmental conditions - natural convection JESD51-3: Low effective thermal conductivity test board for leaded surface mount packages

5. Do not exceed P_D under any circumstances.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
VB	High-Side Floating Supply Voltage	V _S +10	V _S +22	V
V _S	High-Side Floating Supply Offset Voltage	6-V _{DD}	600	V
V _{HO}	High-Side Output Voltage	Vs	V _B	V
V _{DD}	Low-Side and Logic Supply Voltage	10	22	V
V _{LO}	Low-Side Output Voltage	COM	V _{DD}	V
V _{IN}	Logic Input Voltage (HIN and LIN)	COM	V _{DD}	V
T _A	Operating Ambient Temperature	-40	+125	°C
T _{pulse}	Minimum Pulse Width ⁽⁶⁾	80	-	ns

Note:

6. Guaranteed by design. Refer to Figure 28, 29 and 30 on page 11

FAN7190_F085 - High-Current, High & Low Side, Gate-Drive IC

Electrical Characteristics

 V_{BIAS} (V_{DD} , V_{BS})=15.0V, V_S =COM, -40°C <=T_A<= 125°C, unless otherwise specified. The V_{IL} , V_{IH} , and I_{IN} parameters are referenced to COM and are applicable to the respective input signals HIN and LIN. The V_O and I_O parameters are referenced to COM and V_S is applicable to the respective output signals HO and LO.

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
POWER	SUPPLY SECTION (V _{DD} AND V _{BS})					
V _{DDUV+} V _{BSUV+}	V _{DD} and V _{BS} Supply Under-Voltage Positive-going Threshold		7.8	8.8	9.8	
V _{DDUV-} V _{BSUV-}	V _{DD} and V _{BS} Supply Under-Voltage Negative-going Threshold		7.2	8.3	9.1	V
V _{DDUVH} V _{BSUVH}	V _{DD} and V _{BS} Supply Under-Voltage Lockout Hysteresis Voltage			0.5		
I _{LK}	Offset Supply Leakage Current	V _B =V _S =600V			50	
I _{QBS}	Quiescent V _{BS} Supply Current	V _{IN} =0V or 5V		45	110	μA
I _{QDD}	Quiescent V _{DD} Supply Current	V _{IN} =0V or 5V		75	150	
I _{PBS}	Operating V _{BS} Supply Current	f _{IN} =20kHz, rms value		530	700	μA
I _{PDD}	Operating V _{DD} Supply Current	f _{IN} =20kHz, rms value		530	750	μΑ
	IPUT SECTION (HIN, LIN)		•			
V _{IH}	Logic "1" Input Voltage		2.5			V
V _{IL}	Logic "0" Input Voltage				1.2	v
I _{IN+}	Logic "1" Input Bias Current	V _{IN} =5V		25	50	μA
I _{IN-}	Logic "0" Input Bias Current	V _{IN} =0V		1.0	2.0	μΑ
R _{IN}	Input Pull-down Resistance		100	200		KΩ
GATE DR	IVER OUTPUT SECTION (HO, LO)	•				
V _{OH}	High-level Output Voltage, V _{BIAS} -V _O	No Load			1.5	V
V _{OL}	Low-level Output Voltage, VO	No Load			35	mV
I _{O+}	Output High, Short-circuit Pulsed Current ⁽⁶⁾	V _O =0V, V _{IN} =5V with PW<10µs	3.5	4.5		^
I _{O-}	Output Low, Short-circuit Pulsed Current ⁽⁶⁾	V _O =15V, V _{IN} =0V with PW<10µs	3.5	4.5		A
Vs	Allowable Negative V _S Pin Voltage for HIN Signal Propagation to HO			-9.8	-7.0	V

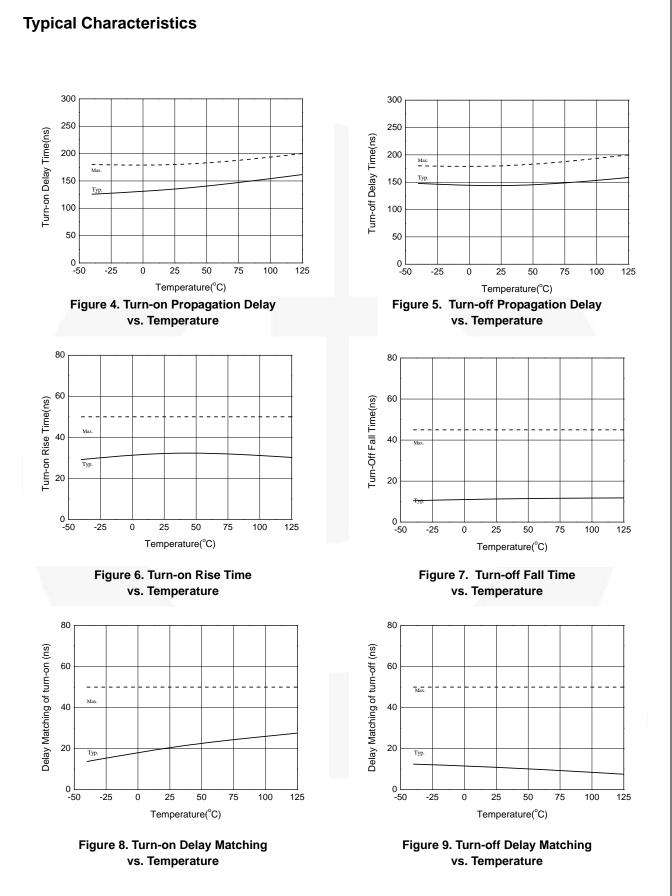
Note:

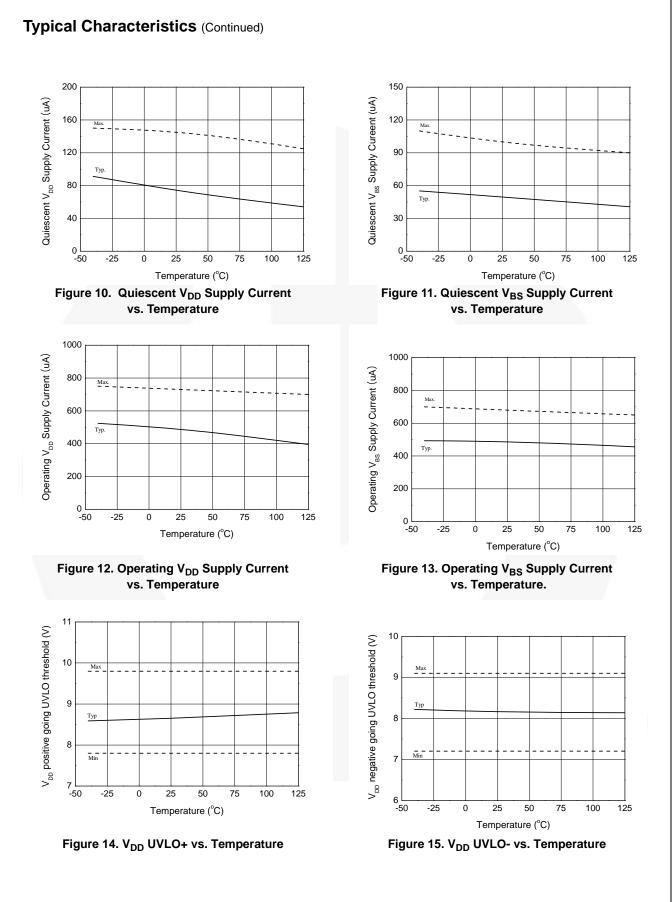
6. This parameter guaranteed by design.

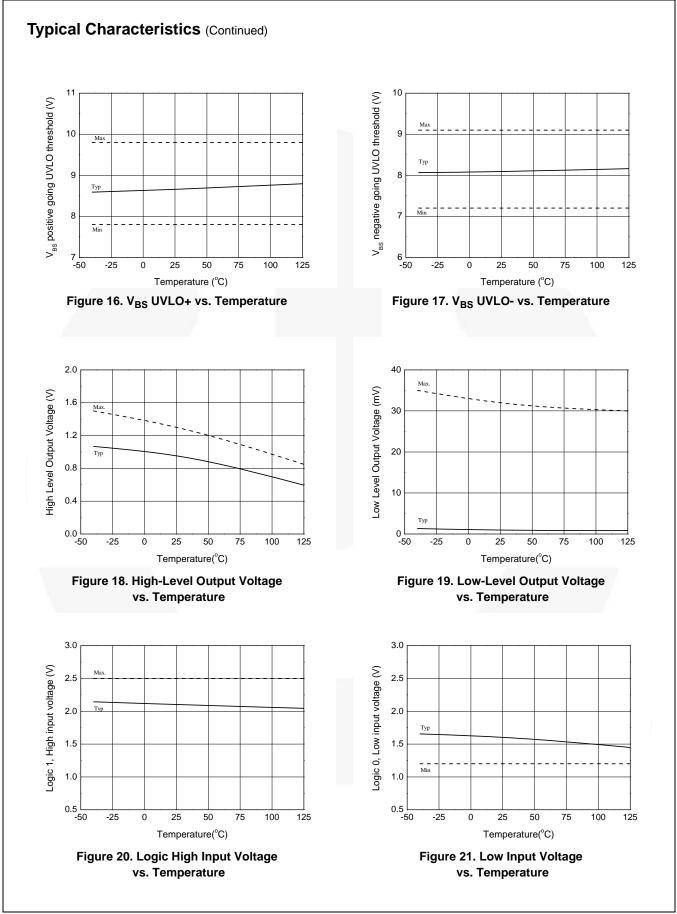
Dynamic Electrical Characteristics

 V_{BIAS} (V_{DD} , V_{BS})=15.0V, V_{S} =COM=0V, C_{L} =1000pF and -40°C <=T_A<= 125°C unless otherwise specified.

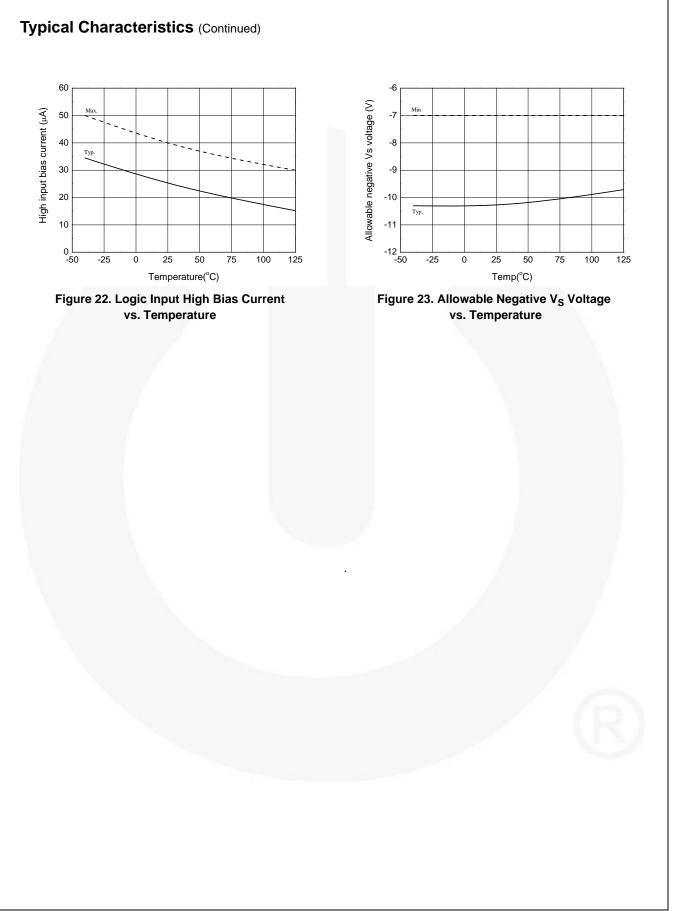
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
t _{on}	Turn-on Propagation Delay	V _S =0V		140	200	~
t _{off}	Turn-off Propagation Delay	V _S =0V		140	200	
MT	Delay Matching, HS & LS Turn-on/off			0	50	ns
t _r	Turn-on Rise Time			25	50	
t _f	Turn-off Fall Time			20	45	

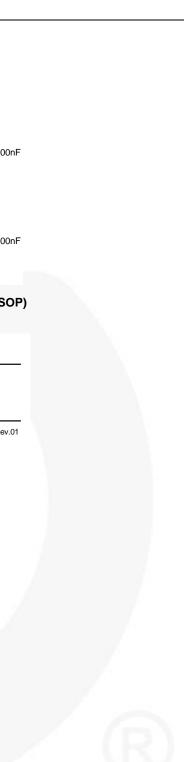


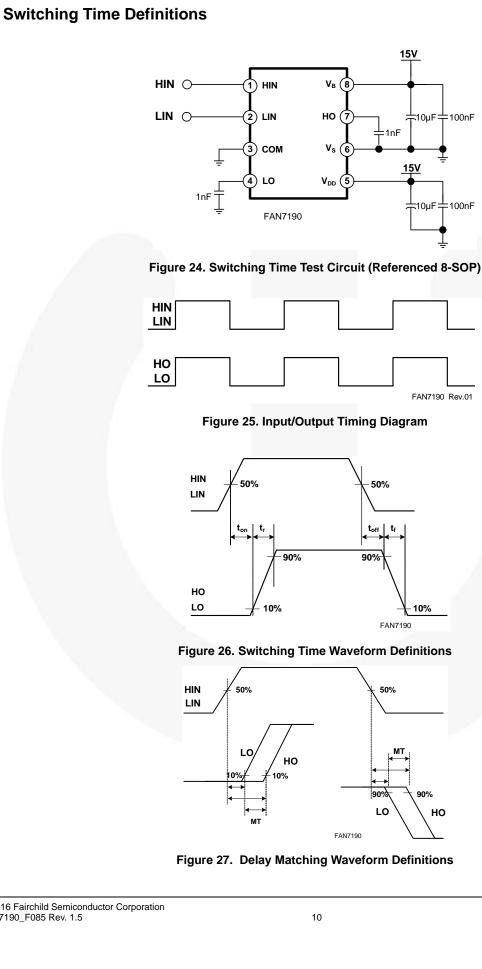


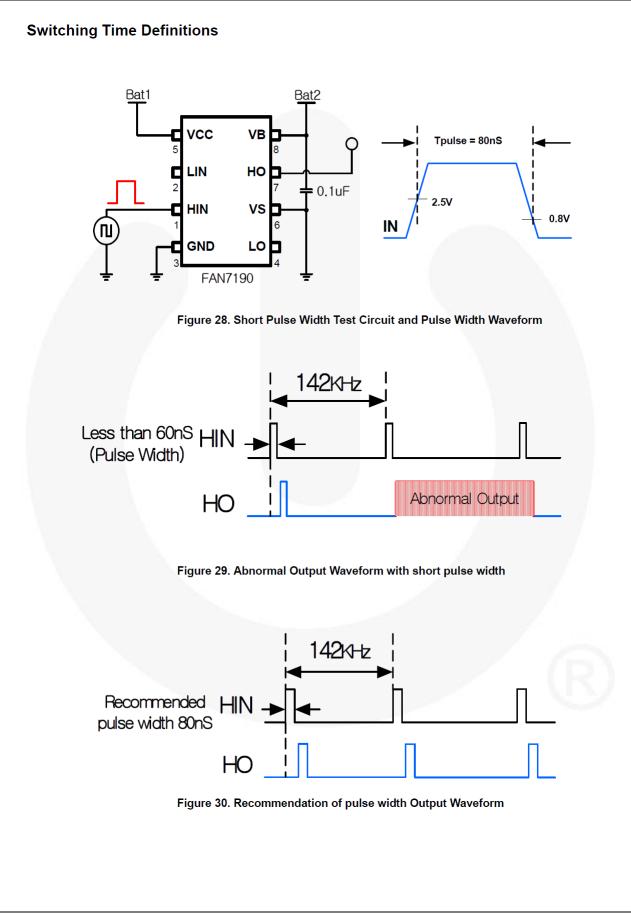


8











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